SK82B THRU SK810B

Reverse Voltage - 20 to 200 Volts Forward Current - 8.0 Ampere

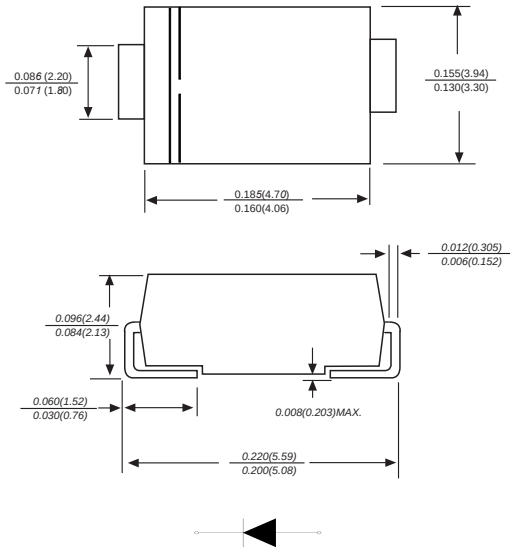
SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Metal silicon junction,majority carrier conduction
- Low power loss,high efficiency
- Built-in strain relief,ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 250 °C/10 seconds at terminals

DO-214AA/SMB

RoHS COMPLIANT



Dimensions in inches and (millimeters)

Mechanical Data

Case : JEDEC DO-214AC/SMA molded plastic body
Terminals : Solderable per MIL-STD-750,Method 2026
Polarity : Color band denotes cathode end Mounting
Position : Any
Weight : 0.002 ounce, 0.07 grams

Maximum Ratings And Electrical Characteristics

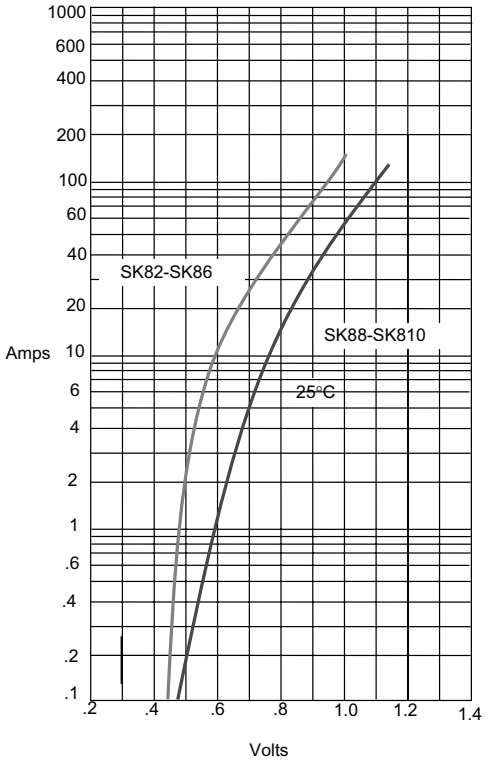
Ratings at 25℃ ambient temperature unless otherwise specified.
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter / Marking Code	SYMBOLS	MDD SK82B	MDD SK83B	MDD SK835B	MDD SK84B	MDD SK845B	MDD SK86B	MDD SK88B	MDD SK810B	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	35	40	45	60	80	100	V
Maximum RMS voltage	V_{RMS}	14	21	24.5	28	31.5	42	56	70	V
Maximum DC blocking voltage	V_{DC}	20	30	35	40	45	60	80	100	V
Maximum average forward rectified current at TL(see fig.1)	$I_{(AV)}$	8.0								A
Peak forward surge current 8.3ms single half sine-wave superimposed onrated load (JEDEC Method)	I_{FSM}	200								A
Maximum instantaneous forward voltage at 8.0A	V_F	0.65							0.85	V
Maximum DC reverse current at rated DC blocking voltage TA=25℃	I_R	1.0								mA
TA=100℃		20.0								
Typical junction capacitance (NOTE 1)	C_J	400								pF
Typical thermal resistance (NOTE 2)	$R_{\theta JA}$	18.0								℃/W
Operating junction temperature range	T_J	-50 to +150								℃
Storage temperature range	T_{STG}	-50 to +150								℃

Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas

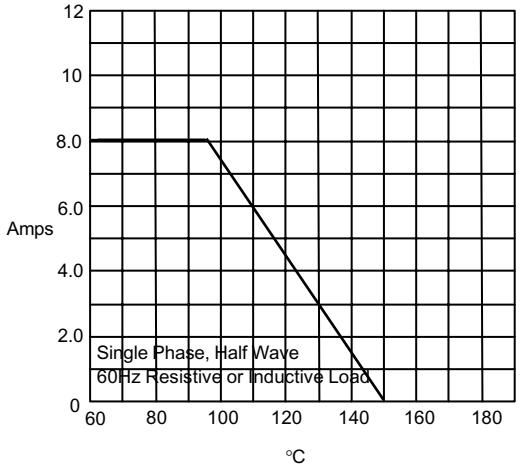
Typical Characterisitics

Figure 1
Typical Forward Characteristics



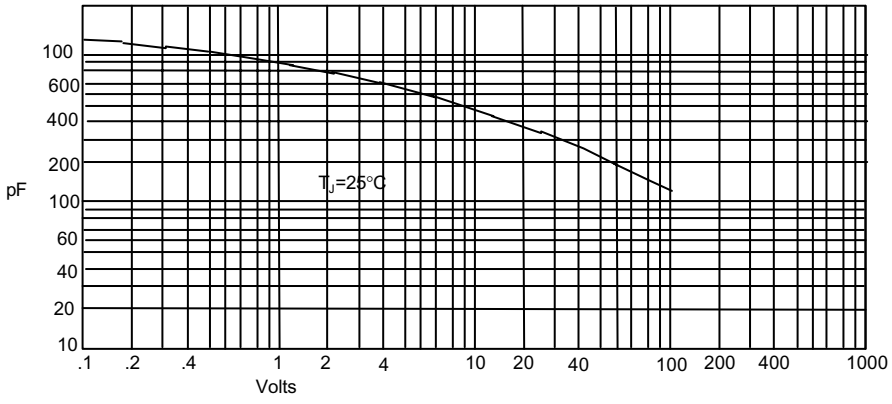
Instantaneous Forward Current - Amperes *versus*
Instantaneous Forward Voltage - Volts

Figure 2
Forward Derating Curve



Average Forward Rectified Current - Amperes *versus*
Junction Temperature -°C

Figure 3
Junction Capacitance

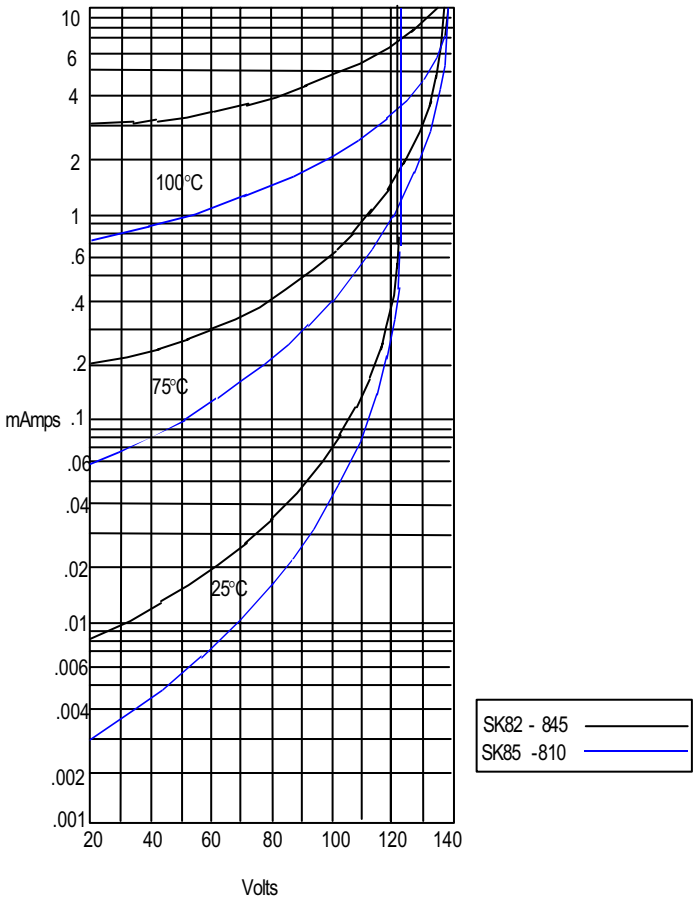


Junction Capacitance - pF *versus*
Reverse Voltage - Volts

The curve above is for reference only.

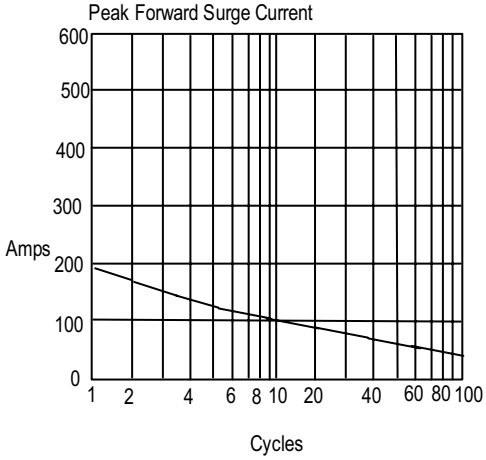
Typical Characterisitics

Figure 4
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperes *versus*
Percent Of Rated Peak Reverse Voltage - Volts

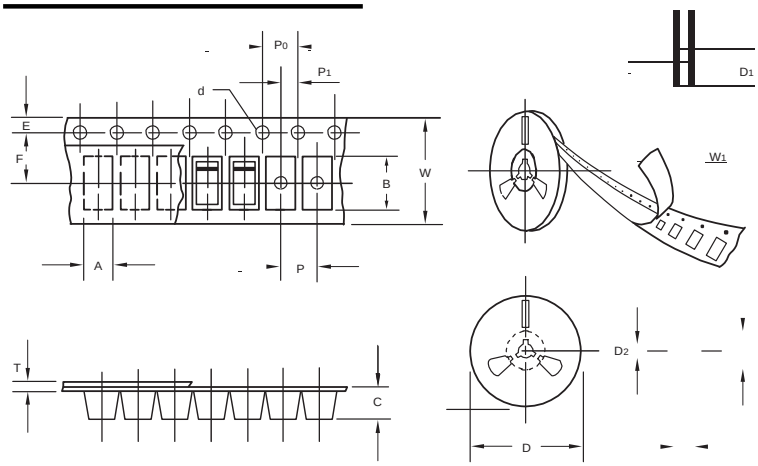
Figure 5
Peak Forward Surge Current



Peak Forward Surge Current - Amperes *versus*
Number Of Cycles At 60Hz - Cycles

The curve above is for reference only.

Packing information



unit:mm

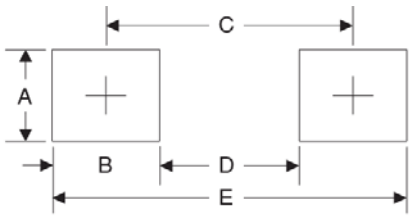
Item	Symbol	Tolerance	SMA
Carrier width	A	0.1	2.80
Carrier length	B	0.1	5.33
Carrier depth	C	0.1	2.36
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D_1	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D_1	min	62.00
Feed hole diameter	D_2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P_0	0.1	4.00
Embossment center	P_1	0.1	2.00
Overall tape thickness	T	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W_1	1.0	18.00

Note:Devices are packed in accor dance with EIA standar RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA, (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMB	13"	3,000	4.0	6,000	190*190*41	330	365*365*360	48,000	14.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.90	0.154
D	2.41	0.095
E	5.45	0.215